XL-DZ304UGD/2 技术数据表

F3MM 绿发绿双孔灯座

特点（ ）：

* :10.0*9.0*4.5mm

Appearance dimension :10.0*9.0*4.5mm

* : /

Luminous color and colloid:green Light /green colloid

* ROHS

Environmental protection products meet ROHS requirements

* MSL :2

Moisture sensitivity level MSL : 2 levels

* EIA

EIA standard packaging

*

Long operating life

*

Reduced maintenance costs

*

High energy efficiency, fast startup

应用领域（product application）

*

Internet of Things

*

medical treatment

*

converter

*

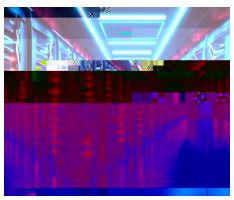
Storage servers and communication

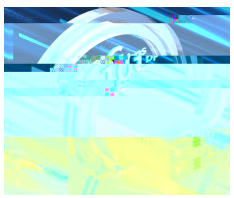
*

Status indicator

*

Electronic testing instruments





电性参数

Parameter	Symbol	Value	Unit
Max Power Dissipation	PD	150	mW
Max Continuous Forward Current	IF	20*2=40	mA
Peak Forward Current	IFP	80*2=160	mA
Max Reverse Voltage	VR	5	V
Antistatic ability	ESD	2000	V
Operating Temperature Range	TOPR	-40 ~ +85	
Storage Temperature Range	TSTR	-40 ~ +85	
/ Lead Soldering Temperature/Time	TSOL	260 Ò6S	/S

Luminous Intensity	Iv	/	6000	/	mcd	IF=20mA
Dominant Wave Length	∂d	515	/	530	nm	IF=20mA
Peak Wave Length	∂p	/	525	/	nm	IF=20mA
Forward Voltage	VF	2.6	/	3.4	V	IF=20mA
Viewing Angle	2Ï1/2	/	45Á	/	deg	IF=20mA
Half wave width	¢∂	/	30	/	nm	IF=20mA
Reverse Curreno						

Part No.:

:

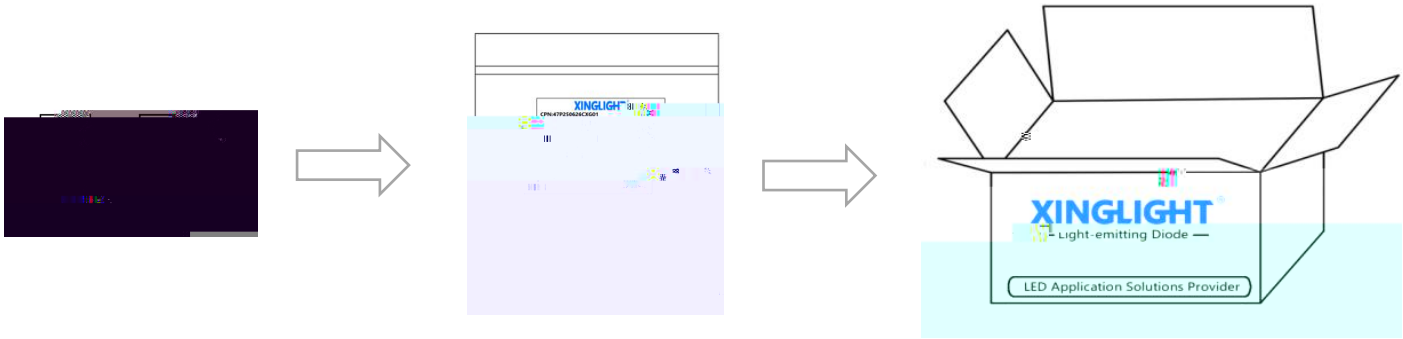
25 + 5 C./Note: If not otherwise indicated, the test jr dir

Part No. :

包装

*
In Bags

*
Moisture Proof and Anti-Electrostatic Foil Bag



XINGLIGHT®

Part

使用注意事项（1）

1、贮存：

*　　LED　　30　　70%　　LED

Storage environment of LED with temperature not exceeding 30　and relative humidity not exceeding 70%.It is recommended that LDE be used in the original box for no more than three months. If longer storage time is required, put it in the drying box and add desiccant or filled with nitrogen.

2、静电：

*

Part

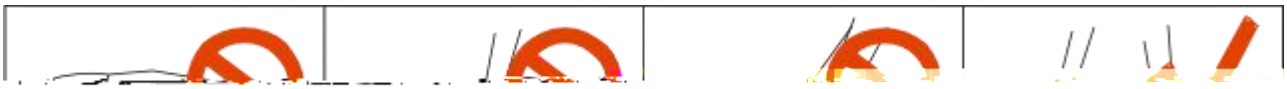
使用注意事项（3）

Precautions (3)

4、其他事项：

*

*When handling the product, touching the encapsulant with bare hands will not only contaminate its surface, but also affect on its optical characteristics. Excessive force to the encapsulant might result in catastrophic failure of the LEDs due to die breakage or wire deformation. For this reason, please do not put excessive stress on LEDs, especially when the LEDs are heated such as during Reflow Soldering.



*LED

*The epoxy resin of encapsulant is fragile, so please avoid scratch or friction over the epoxy resin surface. While handling the product with tweezers, do not hold by the epoxy resin, be careful.

5、眼睛保护忠告：

*LED LED

*Viewing direct to the light emitting center of the LEDs, especially those of great Luminous Intensity, will cause great hazard to human eyes. Please be careful.

If there are any modifications to the specification sheet, no further notice will be given